# ATC 200 B Series BX Ceramic **Multilayer Capacitors**

 Case B Size (.110" x .110")  Capacitance Range 5000 pF to 0.1 μF

Low ESR/ESL

• Mid-K

Rugged Construction

High Reliability

Extended WVDC Available

ATC, the industry leader, offers new improved ESR/ESL performance for the 200 B Series Capacitors. This Series exhibits high volumetric efficiency with superior IR characteristics. Ceramic construction provides a rugged, hermetic package.

Typical functional applications: Bypass, Coupling and DC Blocking.

Typical circuit applications: Switching Power Supplies and High Power Broadband Coupling.

### **ENVIRONMENTAL TESTS**

ATC 200 B Series Capacitors are designed and manufactured to meet and exceed the requirements of EIA-198, MIL-PRF-55681 and MIL-PRF-123.

#### THERMAL SHOCK:

MIL-STD-202, Method 107, Condition A.

#### **MOISTURE RESISTANCE:**

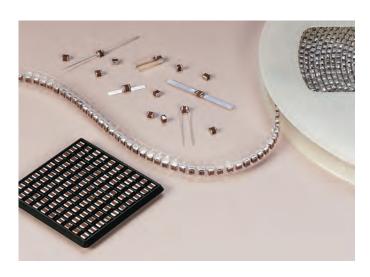
MIL-STD-202, Method 106.

#### LOW VOLTAGE HUMIDITY:

MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours min.

#### LIFE TEST:

MIL-STD-202, Method 108, for 2000 hours, at 125°C. 200% WVDC applied.



### **ELECTRICAL AND MECHANICAL SPECIFICATIONS**

DISSIPATION FACTOR (DF): 2.5% max. @ 1 KHz

### TEMPERATURE COEFFICIENT OF CAPACITANCE (TCC):

±15% maximum (-55°C to +125°C)

#### **INSULATION RESISTANCE (IR):**

5000 pF to 0.1 MFd:

10<sup>4</sup> Megohms min. @ +25°C at rated WVDC. 10<sup>3</sup> Megohms min. @ +125°C at rated WVDC.

#### **WORKING VOLTAGE (WVDC):**

See Capacitance Values Table, page 2.

#### **DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

Case B: 250% of rated WVDC for 5 secs.

**AGING EFFECTS:** 3% maximum per decade hour.

PIEZOELECTRIC EFFECTS: Negligible

**DIELECTRIC ABSORPTION: 2% typical** 

#### **OPERATING TEMPERATURE RANGE:**

From -55°C to +125°C (No derating of working voltage).

#### **TERMINATION STYLES:**

Available in various surface mount and leaded styles. See Mechanical Configurations, page 3.

TERMINAL STRENGTH: Terminations for chips and pellets withstand a pull of 5 lbs. min., 15 lbs. typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor. Test per MIL-STD-202, method 211.



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## ATC 200 B Capacitance Values

CAP.	CAP.	TOL.	RATE	OWVDC	CAP.	CAP.	TOL.	RATED	WVDC					
CODE	(pF)	IOL.	STD.	EXT.*	CODE	(pF)	IOL.	STD.	EXT.*					
502	5000			11.1	273	27,000			11.1					
562	5600		50	50	50	50	1GE	333	33,000			151		
682	6800						50		VOLTA	393	39,000			ITAGE
822	8200							8	473	47,000			8	
103	10,000	IZ M N						50	100	503	50,000	IZ M NI	50	100
123	12,000	K, M, N	30		563	56,000	K, M, N	] 50						
153	15,000			)EL	683	68,000			)EL					
183	18,000			Ž	823	82,000			Ž					
203	20,000			EXTENDED	104	100,000			EXTENDED					
223	22,000			E					E					

 $VRMS = 0.707 \times WVDC$ 

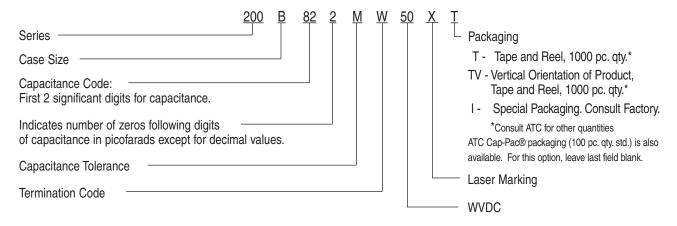
• SPECIAL VALUES, TOLERANCES, HIGHER WVDC AND MATCHING AVAILABLE.
PLEASE CONSULT FACTORY.

\* Extended WVDC offereing meets X7R characteristics

### CAPACITANCE TOLERANCE

Code	K	M	N
Tol.	±10%	±20%	±30%

### ATC PART NUMBER CODE



The above part number refers to a 200 B Series (case size B) 8200 pF capacitor, M tolerance (±20%), 50 WVDC, with W termination (Tin/Lead, Solder Plated over Nickel Barrier), laser marking and ATC Cap-Pac<sup>®</sup> packaging.

For additional information and catalogs contact your ATC representative or call direct at (631) 622-4700.

Consult factory for additional performance data.

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## ATC 200 B Capacitors: Mechanical Configurations

		CASE SIZE		OUTLINES W/T IS A		OY DIMENSIO NCHES (mm)	NS		EAD AND TE	RMINATION D Materials	3
& CASE SIZE	CODE	& TYPE	TERMINATION SURFACE	LENGTH (L)	WIDTH (W)	THICKNESS (T)	OVERLAP (Y)	MATERIALS			
200B	W	B Solder Plate	$\begin{array}{c c} Y \rightarrow & \downarrow & \downarrow \\ \hline & \underline{W} & \underline{W} \\ \rightarrow & \downarrow & \downarrow & \uparrow \rightarrow \uparrow & \uparrow & \uparrow \leftarrow \end{array}$	.110 +.020 010 (2.79 +0.51 -0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59) max.		Tin/Lead, Solder Plated over Nickel Barrier Termination			
200B	Р	B 😭 Pellet	$\begin{array}{c c} Y \to & \downarrow & \downarrow \\ \hline  & \underline{W} & \underline{W} \\  \to & \downarrow & \downarrow & \uparrow \to \uparrow & \uparrow & \uparrow & \downarrow \end{array}$	.110 +.035 010 (2.79 +0.89 -0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59)	.015 (0.38) ±.010 (0.25) max.	Heavy Tin/Lead Coated, over Nickel Barrier Termination			
200B	Т	B Solderable Nickel Barrier	$\begin{array}{c c} Y \to & \downarrow & \downarrow \\ \hline  & \underline{W} & \underline{W} \\  \to & \downarrow & \downarrow & \uparrow \to \uparrow & \uparrow & \uparrow & \downarrow \end{array}$	.110 +.020 010 (2.79 +0.51 -0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59)				r	
200B	CA	B 😭 Gold Chip	$\begin{array}{c c} Y \rightarrow & \downarrow & \downarrow \\ \hline & w & \\ \hline \rightarrow & \downarrow & \uparrow \\ \hline & \downarrow & \uparrow \\ \end{array}$	.110 +.020 010 (2.79 +0.51 -0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59)		RoHS Compliant Gold Plated over Nickel Barrier Termination			
200B	MS	B Microstrip	$\begin{array}{c c} \downarrow & \rightarrow \mid ^{\downarrow} _{L} \mid \leftarrow & \downarrow & \rightarrow \mid \leftarrow \\ \hline \begin{array}{c c} \hline \psi_{L} & & \downarrow & \downarrow & \downarrow \\ \hline \uparrow & \rightarrow \mid L \mid \leftarrow & & \uparrow \\ \hline \end{array} \begin{array}{c c} \hline \psi & & \downarrow \\ \hline \uparrow & \uparrow & \uparrow \\ \hline \end{array}$	.135 ±.015 (3.43 ±0.38)		.120 (3.05) max.		Length (L <sub>L</sub> )	Width (W <sub>L</sub> )	Thickness (T <sub>L</sub> )	
200B	AR	B Axial Ribbon	$\begin{array}{c c} \downarrow & \rightarrow \mid L_{L} \mid \leftarrow & \downarrow \rightarrow \mid \leftarrow \\ \hline \underline{w_{L}} & \hline \downarrow & \hline \downarrow & \underline{w} & \hline \downarrow \\ \uparrow & \rightarrow \mid L \mid \leftarrow & \uparrow \rightarrow \mid \top \mid \leftarrow \\ \end{array}$						.250 (6.35) min.	.093 ±.005 (2.36 ± 0.13)	.004 ± .001 (.102 ± .025)
200B	RR	B Radial Ribbon	$\begin{array}{c c} & & \downarrow & \downarrow & \downarrow \\ \hline & & \downarrow & & \downarrow \\ \hline & & \uparrow & \downarrow & \downarrow \\ \hline & & \uparrow & \downarrow & \downarrow \\ \hline \end{array}$		.110 ±.015 (2.79 ±0.38)	.100 (2.54)	N/A				
200B	RW	B Radial Wire	→ L L L L  → W ←	.145 ±.020		max.		E00 (12 7)	#26 A		
200B	AW	B Axial Wire	→ L	(3.68 ±0.51)				.500 (12.7)		106) dia. ninal	

Additional lead styles available: Narrow Microstrip (NM), Narrow Axial Ribbon (NA) and Vertical Narrow Microstrip (H). Other lead lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant. For a complete military catalog, request American Technical Ceramics document ATC 001-818.

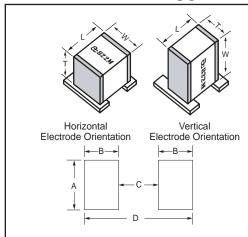
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## ATC 200 B Capacitors: Non-Magnetic Mechanical Configurations

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ATC SERIES	ATC TERM.	MIL-PRF-	CASE SIZE	OUTLINES W/T IS A		OY DIMENSION INCHES (mm		DIM	LEAD AND TERMINATION MENSIONS AND MATERIALS		_S		
& CASE SIZE	CODE	55681	& TYPE	TERMINATION SURFACE	LENGTH (L)	WIDTH (W)	THICKNESS (T)	OVERLAP (Y)		MATERIALS			
200B	WN	Meets Require- ments	B 😭 Non-Mag Solder Plate	$\begin{array}{c c} Y \to & \downarrow & \downarrow \\ \hline  & \underline{w} & \underline{w} \\  \to & \downarrow & \downarrow & \uparrow \to \uparrow & \uparrow \downarrow \leftarrow \end{array}$	.110+.025 010 (2.79 +0.64 -0.25)	.110 ±.015 (2.79 ±0.38)				d, Solder Pla etic Barrier T			
200B	PN	Meets Require- ments	B 😭 Non-Mag Pellet	$\begin{array}{c c} Y \to & \downarrow & \downarrow \\ \hline & w & \hline \\ \to & L & \uparrow \to \uparrow & T & \uparrow \end{array}$	.110+.035 010 (2.79 +0.89 -0.25)	.110 ±.015 (2.79 ±0.38)	.102 (2.59) max			n/Lead, Coated over tic Barrier Termination			
200B	TN	Meets Require- ments	B Non-Mag Solderable Barrier	$\begin{array}{c c} Y \to & \downarrow & \downarrow \\ \hline & w & \hline \\ \to & \downarrow & \downarrow \\ \end{array}$	.110+.025 010 (2.79 +0.64 -0.25)	.110 ±.015 (2.79 ±0.38)			RoHS Compliant Tin Plated over Non-Magnetic Barrier Terminatio				
200B	MN	Meets Require- ments	B Non-Mag Microstrip	$\begin{array}{c c} \downarrow & \rightarrow \mid \downarrow_L \mid \leftarrow \downarrow & \rightarrow \parallel \leftarrow \\ \hline \underline{w_L} & \blacksquare & \blacksquare & \underline{w} & \blacksquare \\ \uparrow & \rightarrow \mid L \mid \leftarrow & \uparrow \downarrow \uparrow \uparrow \downarrow \uparrow \leftarrow \end{array}$			.120 (3.05) max.	N/A		Length (L <sub>L</sub> )	Width (W <sub>L</sub> )	Thickness (T <sub>L</sub> )	
200B	AN	Meets Require- ments	B Non-Mag Axial Ribbon	$\begin{array}{c c} \downarrow & \rightarrow \mid L_{L} \mid \leftarrow & \downarrow \rightarrow \mid \mid \leftarrow \\ \hline \underline{w_{L}} & & \underline{w} & & \underline{w} \\ \uparrow & \rightarrow \mid L \mid \leftarrow & \uparrow \rightarrow \mid T \mid \leftarrow \\ \end{array}$	.135 ±.015 (3.43 ±0.38)		.100 (2.54)		.250 (6.35) (6.35) min.		.004 ± .001 (.102 ± .025)		
200B	FN	Meets Require- ments	B Non-Mag Radial Ribbon	$\begin{array}{c c} & \xrightarrow{\frac{1}{W}} & \xrightarrow{\frac{1}{W}} \downarrow $		.110 ±.015 (2.79 ±0.38)							
200B	RN	Meets Require- ments	B Non-Mag Axial Wire	→   L <sub>L</sub>   ←  →   L   ←  →   W   ←	.145 ±.020				max.		.500 (12.7)	#26 <i>F</i>	NWG., 06) dia.
200B	BN	Meets Require- ments	B Non-Mag RadialWire	→ L L ← ↓ W • ↑ ↑ ↑ ↑ ↑	(3.68 ±0.51)				min.	,	ninal		

Additional lead styles available: Narrow Microstrip (DN), Narrow Axial Ribbon (GN) and Vertical Narrow Microstrip (HN). Other lead lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are **RoHS** compliant.

## **Suggested Mounting Pad Dimensions**



	Pad Size	A Min.	B Min.	C Min.	D Min.
All	Normal	.120	.050	.075	.175
values	High Density	.100	.030	.075	.135

Horizontal Mount								
All	Normal	.130	.050	.075	.175			
values	High Density	.110	.030	.075	.135			

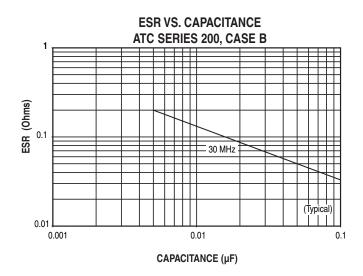
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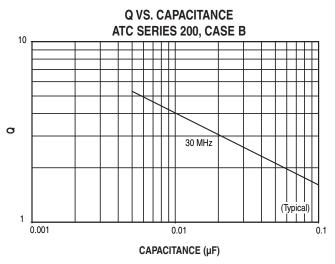
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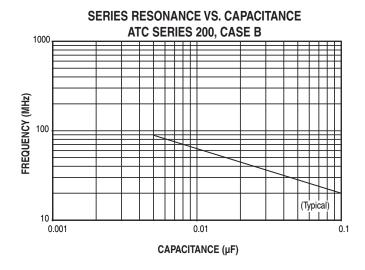
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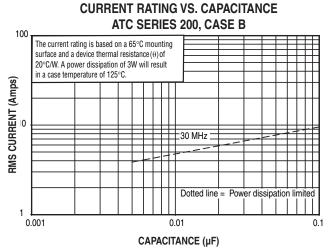
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## ATC 200 B Performance Data









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ATC # 001-812 Rev. O, 7/20



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